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Overvoltage Protection IC with Integrated MOSFET

These devices represent a new level of safety and integration by combining the NCP345 overvoltage protection circuit (OVP) with a 20 V P-channel power MOSFET (NUS2045MN) or with a 30 V P-channel power MOSFET (NUS3045MN). They are specifically designed to protect sensitive electronic circuitry from overvoltage transients and power supply faults. During such hazardous events, the IC quickly disconnects the input supply from the load, thus protecting the load before any damage can occur.

The OVP ICs are optimized for applications using an external AC–DC adapter or a car accessory charger to power a portable product or recharge its internal batteries. They have a nominal overvoltage threshold of 6.85 V which makes them ideal for single cell Li–Ion as well as 3/4 cell NiCD/NiMH applications.

Features

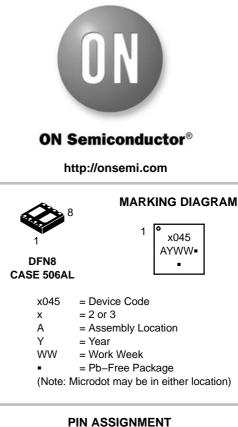
- OvervoltageTurn–Off Time of Less Than 1.0 μs
- Accurate Voltage Threshold of 6.85 V, Nominal
- Undervoltage Lockout Protection; 2.8 V, Nominal
- Control Input Compatible with 1.8 V Logic Levels
- -20 V or -30 V Integrated P-Channel Power MOSFET
- Low $R_{DS(on)} = 71 \text{ m}\Omega$ @ -4.5 V for NUS2045MN Low $R_{DS(on)} = 66 \text{ m}\Omega$ @ -4.5 V for NUS3045MN
- Low Profile 3.3 x 3.3 mm DFN Package Suitable for Portable Applications
- Maximum Solder Reflow temperature @ 235°C for MNT1 suffix and 260°C for MNT1G suffix
- Pb–Free Packages are Available

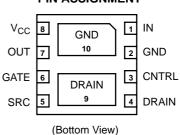
Benefits

- Provide Battery Protection
- Integrated Solution Offers Cost and Space Savings
- Integrated Solution Improves System Reliability

Applications

- Portable Computers and PDAs
- Cell Phones and Handheld Products
- Digital Cameras





ORDERING INFORMATION

Device	Package	Shipping [†]
NUS2045MNT1	DFN8	3000 Tape & Reel
NUS2045MNT1G	DFN8 (Pb–Free)	3000 Tape & Reel
NUS3045MNT1	DFN8	3000 Tape & Reel
NUS3045MNT1G	DFN8 (Pb–Free)	3000 Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

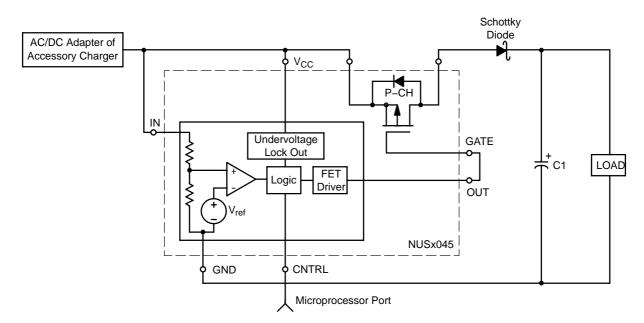


Figure 1. Simplified Schematic

PIN FUNCTION DESCRIPTIONS

Pin #	Symbol	Pin Description
1	IN	This pin senses an external voltage point. If the voltage on this input rises above the overvoltage threshold (V _{TH}), the OUT pin will be driven to within 1.0 V of V _{CC} , thus disconnecting the FET. The nominal threshold level is 6.85 V and this threshold level can be increased with the addition of an external resistor between IN and V _{CC} .
2, 10	GND	Circuit Ground
3	CNTRL	This logic signal is used to control the state of OUT and turn–on/off the P–channel MOSFET. A logic High results in the OUT signal being driven to within 1.0 V of V _{CC} which disconnects the FET. If this pin is not used, the input should be connected to ground.
4, 9	DRAIN	Drain pin of the power MOSFET
5	SRC	Source pin of the power MOSFET
6	GATE	Gate pin of the power MOSFET
7	OUT	This signal drives the gate of a P-channel MOSFET. It is controlled by the voltage level on IN or the logic state of the CNTRL input. When an overvoltage event is detected, the OUT pin is driven to within 1.0 V of V_{CC} in less than 1.0 _sec provided that gate and stray capacitance is less than 12 nF.
8	V _{CC}	Positive Voltage supply. If V_{CC} falls below 2.8 V (nom), the OUT pin will be driven to within 1.0 V of V_{CC} , thus disconnecting the P-channel FET.

OVERVOLTAGE PROTECTION CIRCUIT TRUTH TABLE

IN	CNTRL	OUT
<v<sub>th</v<sub>	L	GND
<v<sub>th</v<sub>	н	V _{CC}
>V _{th}	L	V _{CC}
>V _{th}	Н	V _{CC}

Rating Pin Symbol Min Max Unit OUT Voltage to GND 7 Vo -0.3 30 V Input and CNTRL Pin Voltage to GND 1 Vinput -0.3 30 V 3 -0.3 13 VCNTRL Vcc Maximum Range 8 V_{CC(max)} -0.3 30 V Maximum Power Dissipation (Note 1) W P_D 1.0 _ _ OVP IC 108.6 °C/W Thermal Resistance Junction-to-Air (Note 1) $R_{\theta JA}$ _ _ P-Channel FET 104.3 **Junction Temperature** ТJ 150 °C _ _ **Operating Ambient Temperature** -40 °C _ TA 85 V _ 0 5.0 V_{CNTRL} Operating Voltage 3 -65 150 °C Storage Temperature Range T_{stq} _ ESD Performance (HBM) (Note 2) 1,2,3,7,8,10 2.5 k٧ _ _ Drain-to-Source Voltage VDSS V NUS2045MN -20 NUS3045MN -30 V Gate-to-Source Voltage V_{GS} NUS2045MN -8 8 NUS3045MN -20 20 Continuous Drain Current, Steady State, $T_A = 25^{\circ}C$ (Note 1) А I_D NUS2045MN -1.0 NUS3045MN -1.0

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise stated)

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 inch sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

2. Human body model (HBM): MIL STD 883C Method 3015–7, (R = 1500 Ω , C = 100 pF, F = 3 pulses delay 1 s).

Characteristic	Symbol	Pin	Min	Тур	Max	Unit
V _{CC} Operating Voltage Range	V _{CC(opt)}	8	3.0	4.8	25	V
Supply Current (I _{CC} + Input; V_{CC} = 6.0 V Steady State)	-	1, 8	-	0.75	1.0	mA
Input Threshold (V _{Input} connected to V _{CC} ; V _{Input} increasing)	V _{Th}	1	6.65	6.85	7.08	V
Input Hysteresis (V_{Input} connected to V_{CC} ; V_{Input} decreasing)	V _{Hyst}	1	50	100	200	mV
Input Impedance (Input = V _{Th})	R _{in}	1	70	150	-	kΩ
CNTRL Voltage High	V _{ih}	3	1.5	_	-	V
CNTRL Voltage Low	V _{il}	3	-	_	0.5	V
CNTRL Current High (V _{ih} = 5.0 V)	l _{ih}	3	-	95	200	μΑ
CNTRL Current Low (V _{il} = 0.5 V)	l _{il}	3	-	10	20	μΑ
Undervoltage Lockout (V _{CC} decreasing)	V _{Lock}	3	2.5	2.8	3.0	V
Output Sink Current ($V_{CC} < V_{Th}$, $V_{OUT} = 1.0$ V)	I _{Sink}	7	10	33	50	μΑ
Output Voltage High ($V_{CC} = V_{in} = 8.0 \text{ V}$; $I_{Source} = 10 \text{ mA}$) Output Voltage High ($V_{CC} = V_{in} = 8.0 \text{ V}$; $I_{Source} = 0.25 \text{ mA}$) Output Voltage High ($V_{CC} = V_{in} = 8.0 \text{ V}$; $I_{Source} = 0 \text{ mA}$)	V _{oh}	7	V _{CC} -1.0 V _{CC} -0.25 V _{CC} -0.1	_	-	V
Output Voltage Low (Input < 6.5 V; $I_{Sink} = 0$ mA; $V_{CC} = 6.0$ V, CNTRL = 0 V)	V _{ol}	7	-	_	0.1	V
Turn ON Delay – Input (Note 3) $(V_{Input} \text{ connected to } V_{CC}; V_{Input} \text{ step down signal from 8.0 to 6.0 V; measured to 50% point of OUT)*}$	T _{ON IN}	7	-	-	10	μs
Turn OFF Delay – Input (V_{Input} connected to V_{CC} ; V_{Input} step up signal from 6.0 to 8.0 V; C_L = 12 nF Output > V_{CC} – 1.0 V)	T _{OFF IN}	7	-	0.5	1.0	μs
Turn ON Delay – CNTRL (CNTRL step down signal from 2.0 to 0.5 V; measured to 50% point of OUT) (Note 3)	T _{ON CT}	7	-	-	10	μs
Turn OFF Delay – CNTRL (CNTRL step up signal from 0.5 to 2.0 V; $C_L = 12 \text{ nF}$ Output > $V_{CC} - 1.0 \text{ V}$)	T _{OFF CT}	7	-	1.0	2.0	μs

ELECTRICAL CHARACTERISTICS (T_A = 25°C, Vcc = 6.0 V, unless otherwise specified)

3. Guaranteed by design.

P-CHANNEL MOSFET

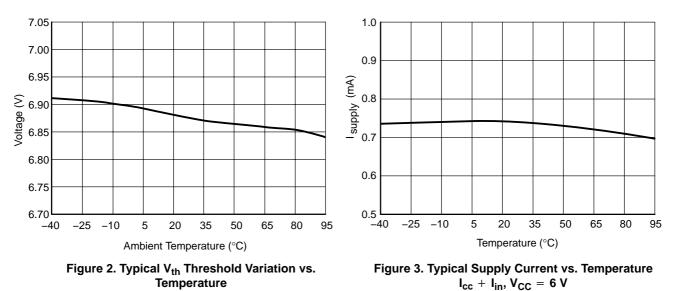
Parameter		Symbol	Min	Тур	Max	Units
Drain to Source On Resistance $V_{GS} = -4.5 \text{ V}, I_D = 600 \text{ mA}$ $V_{GS} = -4.5 \text{ V}, I_D = 1.0 \text{ A}$ $V_{GS} = -4.5 \text{ V}, I_D = 600 \text{ mA}$ $V_{GS} = -4.5 \text{ V}, I_D = 1.0 \text{ A}$	NUS2045MN NUS2045MN NUS3045MN NUS3045MN	R _{DS(on)}		71 71 66 66	95 95 110 110	mΩ
Zero Gate Voltage Drain Current $V_{GS} = 0 V, V_{DS} = -16 V$ $V_{GS} = 0 V, V_{DS} = -24 V$	NUS2045MN NUS3045MN	I _{DSS}			-1.0 -1.0	μΑ
Turn On Delay (Note 4) $V_{GS} = -4.5 V$ $V_{GS} = -4.5 V$	NUS2045MN NUS3045MN	t _{on}		7.5 11		ns
Turn Off Delay (Note 4) $V_{GS} = -4.5 V$ $V_{GS} = -4.5 V$	NUS2045MN NUS3045MN	t _{off}		30.2 28		ns
Input Capacitance (Note 3) $V_{GS} = 0 V$, f = 1.0 MHz, $V_{DS} = -10 V$ $V_{GS} = 0 V$, f = 1.0 MHz, $V_{DS} = -15 V$	NUS2045MN NUS3045MN	C _{in}		675 750		pF
Gate to Source Leakage Current $V_{GS} = \pm 8.0 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	NUS2045MN NUS3045MN	I _{GSS}		±10 ±10		nA
Drain to Source Breakdown Voltage V_{GS} = 0 V, I _D = -250 μ A	NUS2045MN NUS3045MN	V _{(BR)DSS}	20 30			V
Gate Threshold Voltage $V_{GS} = V_{DS}, I_D = -250 \ \mu A$	NUS2045MN NUS3045MN	V _{(GS)th}	-1.2 -3.0		-0.4 -1.0	V

4. Switching characteristics are independent of operating junction temperature.

TYPICAL PERFORMANCE CURVES

(T_A= 25°C, unless otherwise specified)

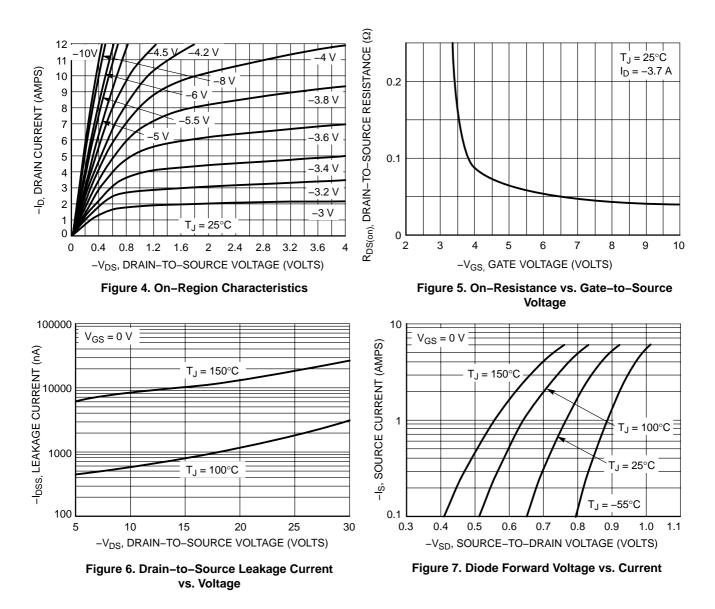
OVERVOLTAGE PROTECTION IC



TYPICAL PERFORMANCE CURVES

(T_A= 25°C, unless otherwise specified)

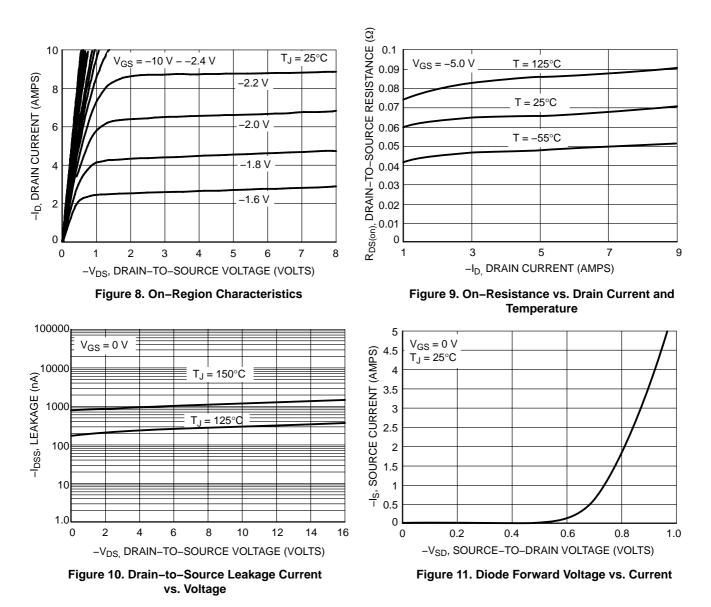
30 V, P-CHANNEL MOSFET



TYPICAL PERFORMANCE CURVES

(T_A= 25°C, unless otherwise specified)

20 V, P-CHANNEL MOSFET



TYPICAL APPLICATION CIRCUITS & OPERATION WAVEFORMS

(T_A= 25°C, unless otherwise specified)



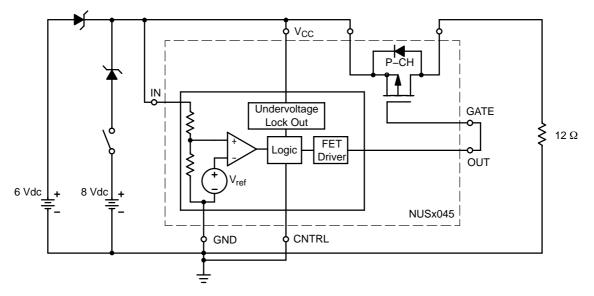


Figure 12. Test Circuit for $T_{\text{ON IN}}$ and $T_{\text{OFF IN}}$

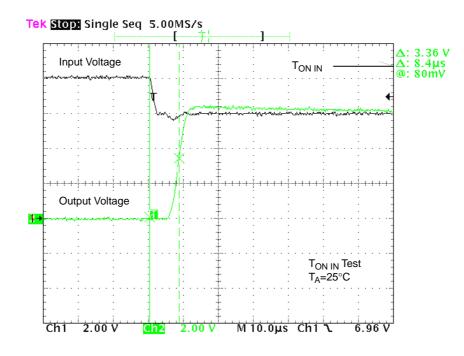


Figure 13. T_{ON IN} Waveforms

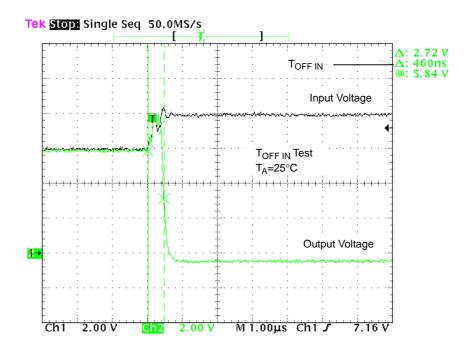


Figure 14. T_{OFF IN} Waveforms

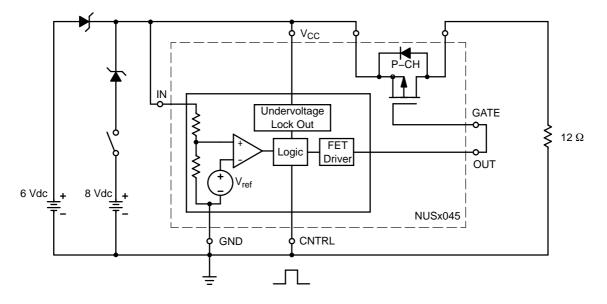


Figure 15. Test Circuit for $T_{ON\,CT}$ and $T_{OFF\,CT}$

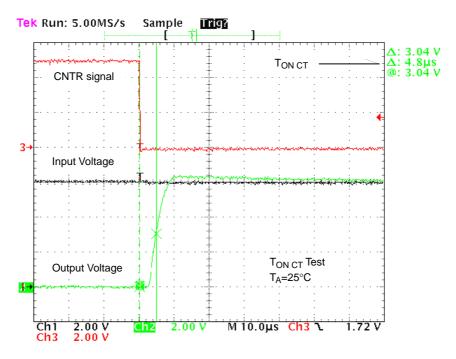


Figure 16. T_{ON CT} Waveforms

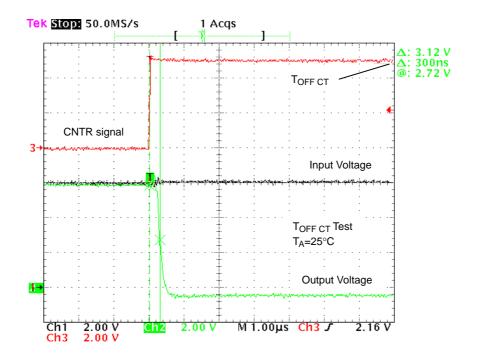
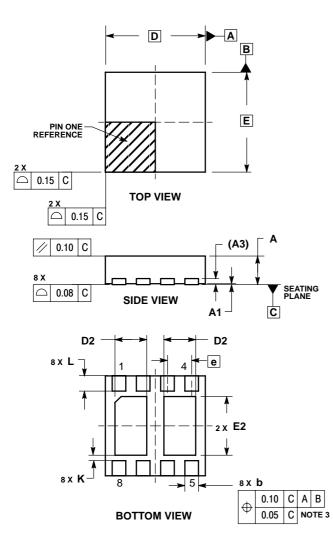


Figure 17. T_{OFF CT} Waveforms

PACKAGE DIMENSIONS

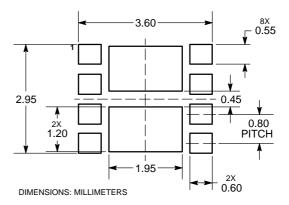
DFN8 CASE 506AL-01 ISSUE A



- NOTES:
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND
- 0.30mm. 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS			
DIM	MIN	MAX		
Α	0.80	0.90	1.00	
A1	0.00	0.03	0.05	
A3	0.20 REF			
b	0.35	0.40	0.45	
D	3.30 BSC			
D2	0.95	1.05	1.15	
Е	3.30 BSC			
E2	1.80	1.90	2.00	
е	0.80 BSC			
κ	0.21			
L	0.30	0.40	0.50	

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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